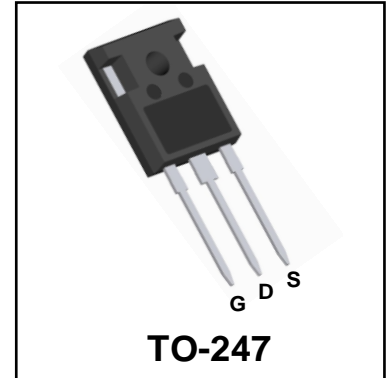


300V 65A 55mΩ N-ch Power MOSFET

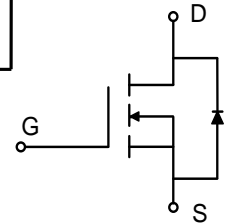
Description

WMJ69N30DMH is Wayon's 1st generation VDMOS family that is dramatic reduction in on-resistance and ultra-low gate charge for applications requiring high power density and high efficiency. And it is very robust and RoHS compliant.



Features

- $V_{DS} = 300V$, $I_D = 65A$
 $R_{DS(on)} < 55m\Omega @ V_{GS} = 10V$
- Green Device Available
- Low Gate Charge
- 100% EAS Guaranteed



Applications

- SMPS
- Charger
- DC/DC Converter

Absolute Maximum Ratings ($T_A = 25^\circ C$, unless otherwise noted)

| Parameter | | Symbol | Value | Unit |
|--|---------------------|----------------|------------|------------|
| Drain-Source Voltage | | V_{DS} | 300 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current | $T_C = 25^\circ C$ | I_D | 65 | A |
| | $T_C = 100^\circ C$ | | 41 | |
| Pulsed Drain Current ¹ | | I_{DM} | 260 | A |
| Single Pulse Avalanche Energy ² | | EAS | 1280 | mJ |
| Total Power Dissipation | $T_C = 25^\circ C$ | P_D | 568 | W |
| Operating Junction and Storage Temperature Range | | T_J, T_{STG} | -55 to 150 | $^\circ C$ |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|--|-----------------|-------|--------------|
| Thermal Resistance from Junction-to-Ambient ³ | $R_{\theta JA}$ | 50 | $^\circ C/W$ |
| Thermal Resistance from Junction-to-Case | $R_{\theta JC}$ | 0.22 | $^\circ C/W$ |

Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit | |
|--|-------------------------|---|------------------------------|------|-----------|------------|---------|
| Static Characteristics | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 300 | - | - | V | |
| Gate-body Leakage current | I_{GSS} | $V_{DS} = 0V, V_{GS} = \pm 20V$ | - | - | ± 100 | nA | |
| Zero Gate Voltage Drain Current | $T_J=25^\circ\text{C}$ | I_{DSS} | $V_{DS} = 300V, V_{GS} = 0V$ | - | - | 1 | μA |
| | $T_J=100^\circ\text{C}$ | | | - | - | 100 | |
| Gate-Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 2.4 | 2.8 | 3.2 | V | |
| Drain-Source on-Resistance ⁴ | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 20A$ | - | 43 | 55 | m Ω | |
| Forward Transconductance ⁴ | g_{fs} | $V_{DS}=10V, I_D=20A$ | - | 51 | - | S | |
| Dynamic Characteristics⁵ | | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 150V, V_{GS} = 0V, f = 1MHz$ | - | 5550 | - | μF | |
| Output Capacitance | C_{oss} | | - | 290 | - | | |
| Reverse Transfer Capacitance | C_{rss} | | - | 165 | - | | |
| Gate Resistance | R_g | $f = 1MHz$ | - | 1 | - | Ω | |
| Switching Characteristics⁵ | | | | | | | |
| Total Gate Charge | Q_g | $V_{GS} = 10V, V_{DS} = 150V, I_D=20A$ | - | 383 | - | nC | |
| Gate-Source Charge | Q_{gs} | | - | 39.8 | - | | |
| Gate-Drain Charge | Q_{gd} | | - | 170 | - | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{GS} = 10V, V_{DD} = 150V, R_G = 3\Omega, I_D = 20A$ | - | 20.8 | - | ns | |
| Rise Time | t_r | | - | 61.2 | - | | |
| Turn-off Delay Time | $t_{d(off)}$ | | - | 278 | - | | |
| Fall Time | t_f | | - | 70 | - | | |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 20A, di/dt=100A/\mu s$ | - | 380 | - | ns | |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 5174 | - | nC | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Diode Forward Voltage ⁴ | V_{SD} | $I_S = 20A, V_{GS} = 0V$ | - | - | 1.2 | V | |
| Continuous Source Current | I_S | $T_C=25^\circ\text{C}$ | - | - | 65 | A | |

Notes:

1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ\text{C}$.
2. The test condition is $V_{DD}=50V, V_{GS}=10V, L=0.4mH, I_{AS}=80A$.
3. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
4. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
5. This value is guaranteed by design hence it is not included in the production test.

Typical Characteristics

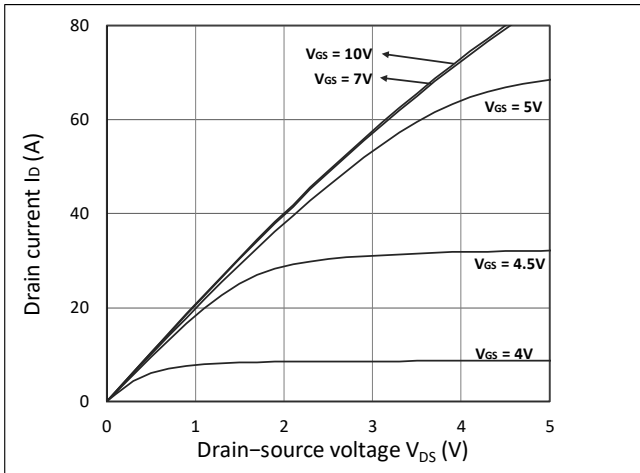


Figure 1. Output Characteristics

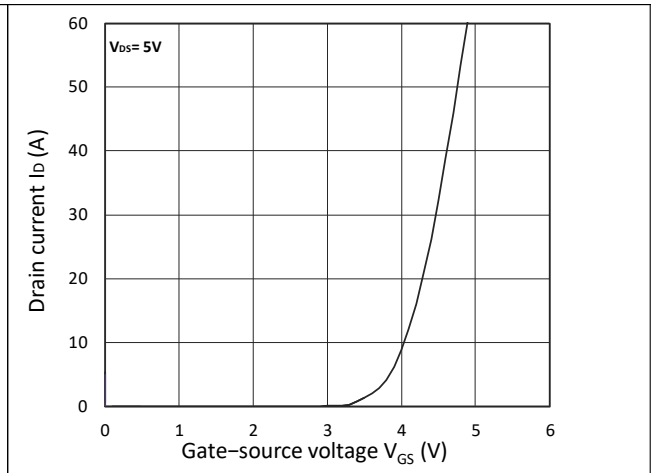


Figure 2. Transfer Characteristics

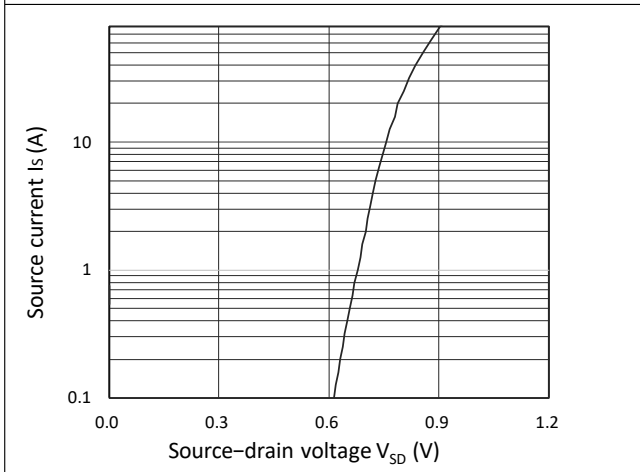


Figure 3. Forward Characteristics of Reverse

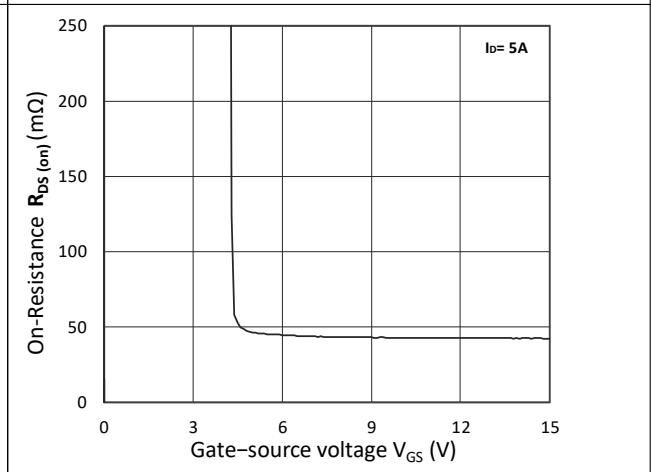


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

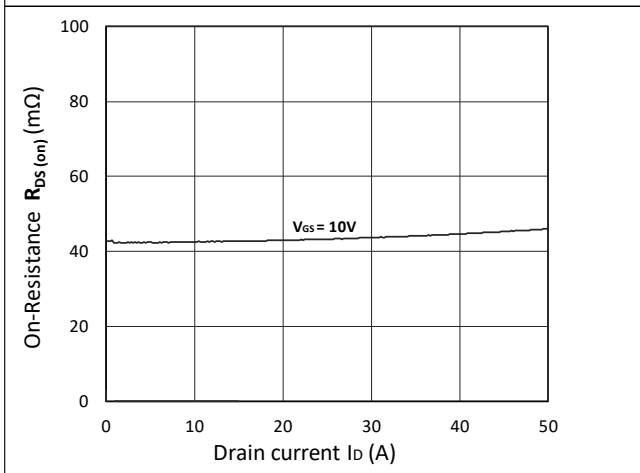


Figure 5. $R_{DS(ON)}$ vs. I_D

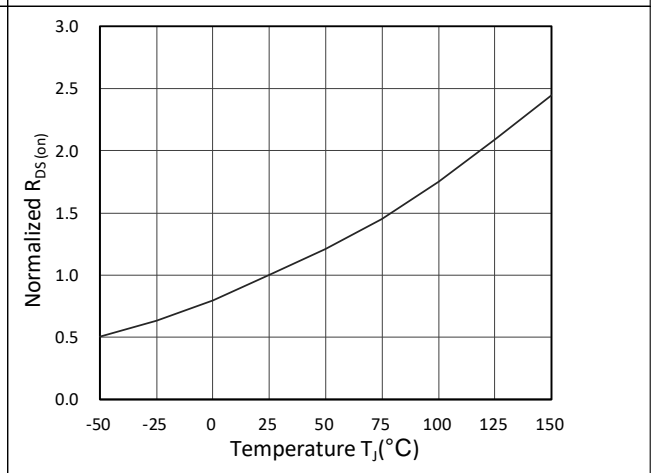


Figure 6. Normalized $R_{DS(ON)}$ vs. Temperature

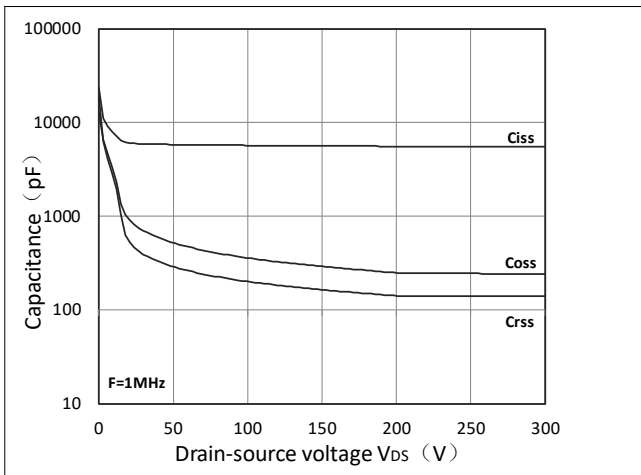


Figure 7. Capacitance Characteristics

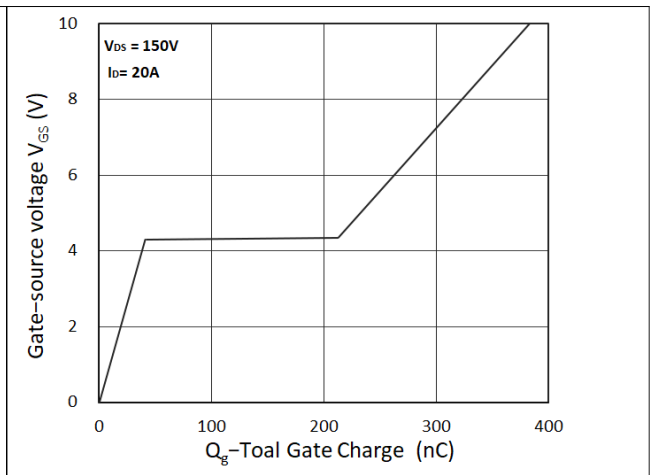


Figure 8. Gate Charge Characteristics

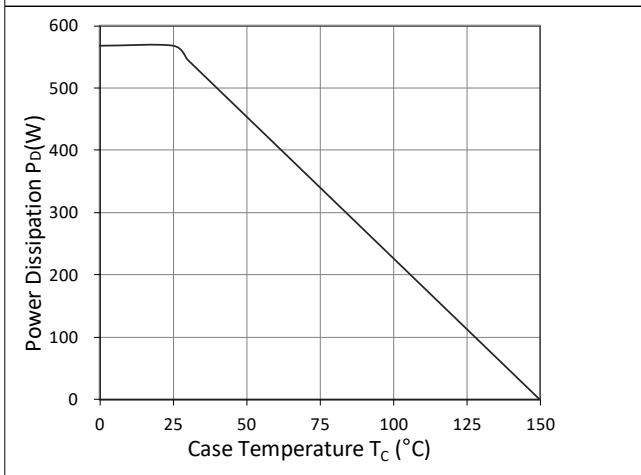


Figure 9. Power Dissipation

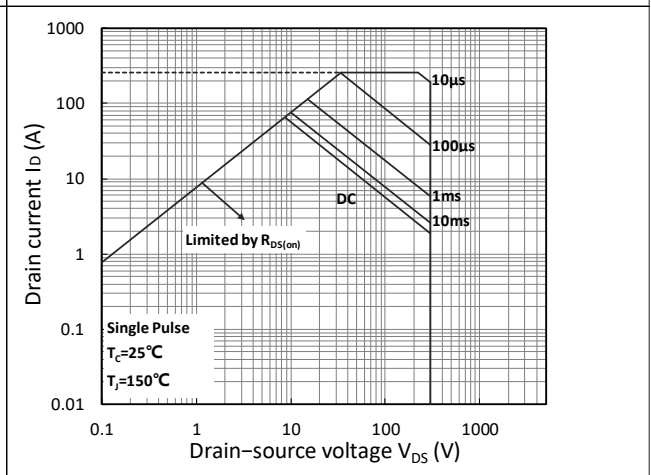


Figure 10. Safe Operating Area

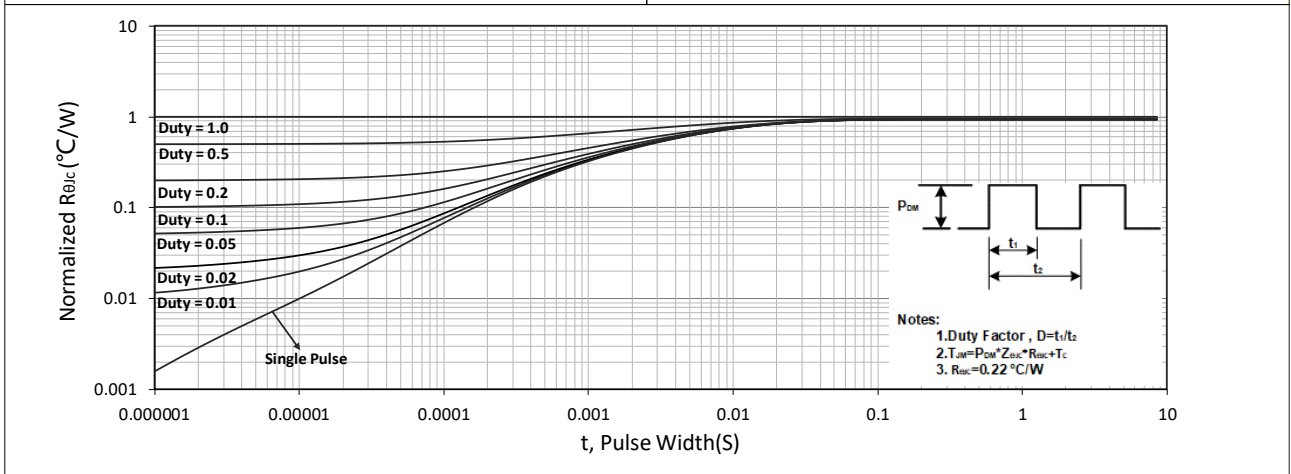


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

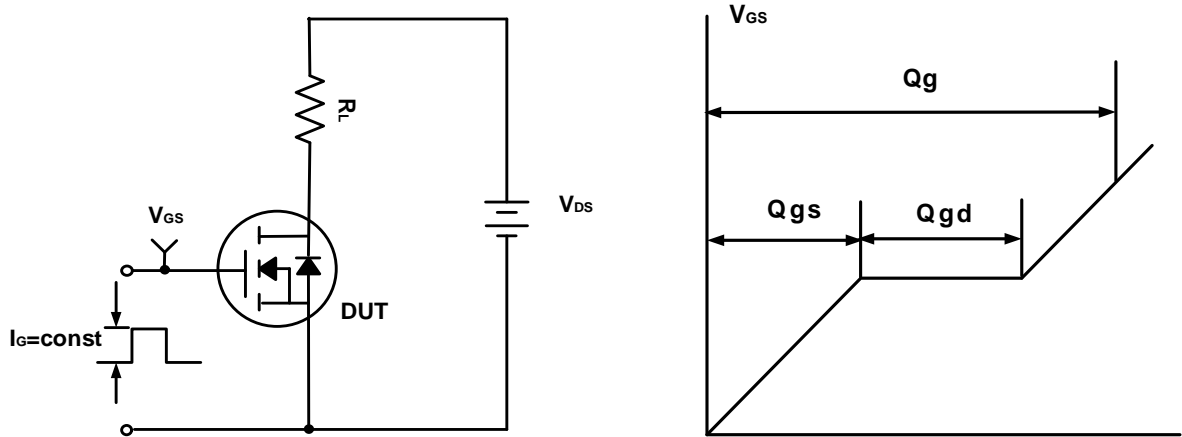


Figure A. Gate Charge Test Circuit & Waveforms

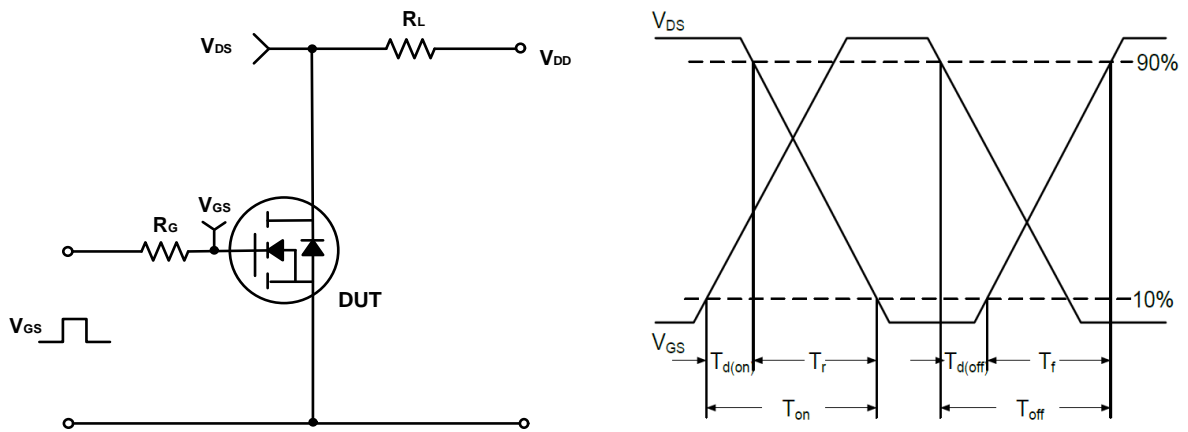


Figure B. Switching Test Circuit & Waveforms

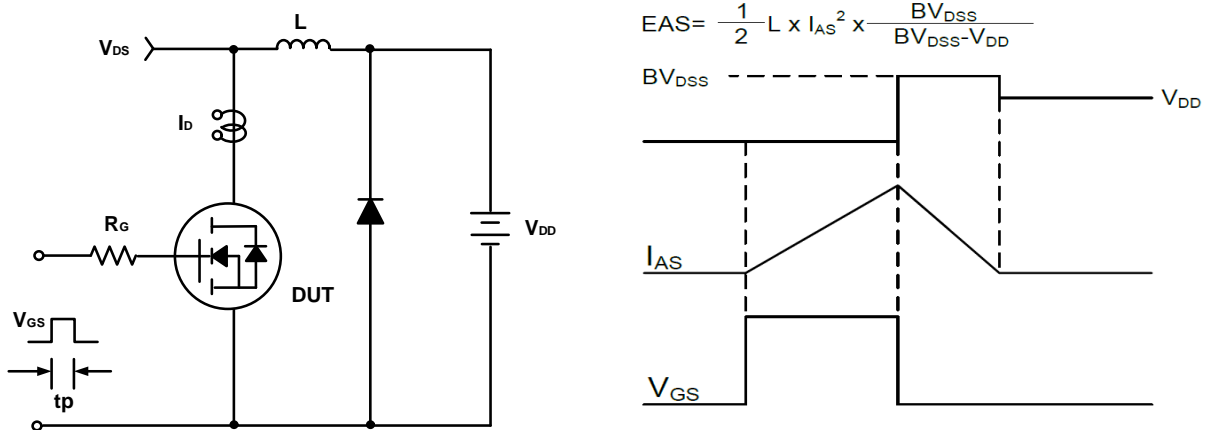
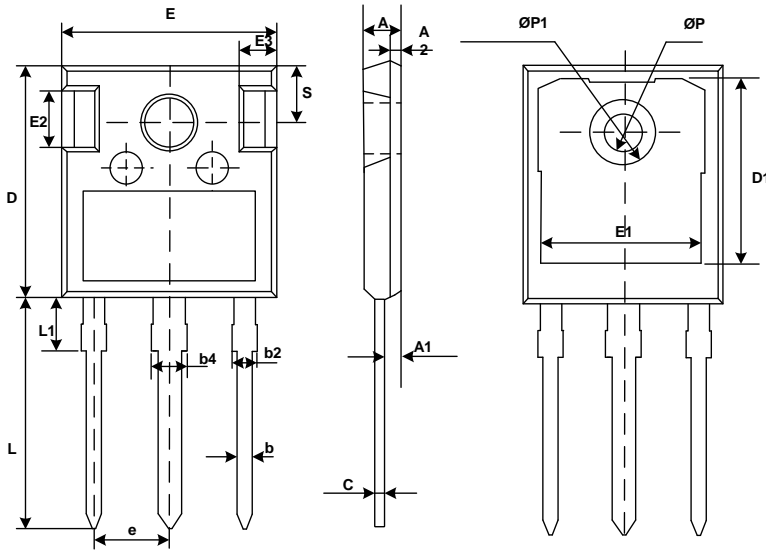


Figure C. Unclamped Inductive Switching Circuit & Waveforms

Mechanical Dimensions for TO-247

COMMON DIMENSIONS

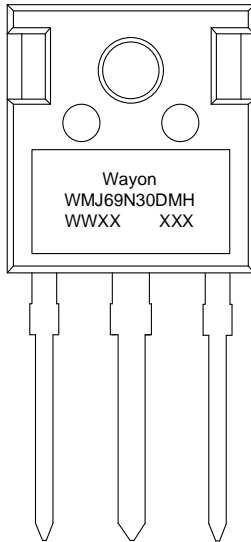


| SYMBOL | MM | |
|--------|----------|-------|
| | MIN | MAX |
| A | 4.80 | 5.20 |
| A1 | 2.21 | 2.61 |
| A2 | 1.85 | 2.15 |
| b | 1.11 | 1.36 |
| b2 | 1.91 | 2.21 |
| b4 | 2.91 | 3.21 |
| c | 0.51 | 0.75 |
| D | 20.70 | 21.30 |
| D1 | 16.25 | 16.85 |
| E | 15.50 | 16.10 |
| E1 | 13.00 | 13.60 |
| E2 | 4.80 | 5.20 |
| E3 | 2.30 | 2.70 |
| e | 5.44 BSC | |
| L | 19.62 | 20.22 |
| L1 | - | 4.30 |
| ØP | 3.40 | 3.80 |
| ØP1 | - | 7.30 |
| S | 6.15 BSC | |

Ordering Information

| Part | Package | Marking | Packing method |
|-------------|---------|-------------|----------------|
| WMJ69N30DMH | TO-247 | WMJ69N30DMH | Tube |

Marking Information



WMJ69N30DMH = Device code

WWXX XXX = Date code

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